

Attorney Docket No. 061063-0317066  
Client Reference: OSP-18862

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: **AKIRA OKUBO, HIDEYUKI KONDO**

Application No.:

Confirmation

No:

Filed: August 1, 2005

Group No.:

Examiner

For: **INSPECTION METHOD, MANUFACTURING METHOD OF PIECE FOR ANALYSIS,  
ANALYSIS METHOD, ANALYZER, MANUFACTURING METHOD OF SOI WAFER,  
AND SOI WAFER**

**Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

**APPLICATION DATA SHEET  
37 C.F.R. § 1.76**

**BIBLIOGRAPHIC DATA**

**1. Applicant information**

First applicant: **AKIRA OKUBO**  
Citizenship: **JAPAN**  
Residence: **Tokyo, JAPAN**

Second applicant: **HIDEYUKI KONDO**  
Citizenship: **JAPAN**  
Residence: **Tokyo, JAPAN**

**2. Correspondence information**

Correspondence for this application should be addressed as follows:

Customer No.: 00909

**3. Application information**

Title of Invention: **INSPECTION METHOD, MANUFACTURING METHOD OF PIECE FOR  
ANALYSIS, ANALYSIS METHOD, ANALYZER, MANUFACTURING METHOD OF SOI  
WAFER, AND SOI WAFER**

Docket number assigned to this application: 061063-0317066

Suggested Classification:

Class:

Subclass:

Technology Center to which subject matter is assigned:

Total number of drawing sheets: 7  
Type of application: Utility  
Application is to be published. Suggested drawing figure for publication:

Secrecy order under § 5.2:

This application does not disclose subject matter of an application which is under a secrecy order pursuant to § 5.2.

**4. Representative information**

The following have a power of attorney or authorization of agent in this application:

Customer No.: 00909

**5. Domestic Priority information**

Domestic priority for this application is claimed as follows:

35 U.S.C. § 365(c):  
Application No.: PCT/JP2003/013271  
Filed: October 16, 2003  
Status: Pending  
Relationship: Parent

**6. Foreign priority information**

Foreign priority is claimed for this application as follows:

Country: JAPAN  
Application No.: 2003-026540  
Filing Date: February 3, 2003  
Status: Pending

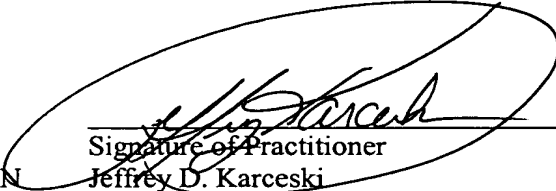
**7. Assignee information**

The assignee(s) of this application is/are:

Sumitomo Mitsubishi Silicon Corporation  
2-1, Shibaura 1-chome, Minato-ku  
Tokyo,  
JAPAN  
Extent of interest of assignee in application: 100%

Date: August 1, 2005

PILLSBURY WINTHROP SHAW PITTMAN  
LLP  
P.O. Box 10500  
McLean, VA 22102  
Customer No. 00909



Signature of Practitioner  
Jeffrey D. Karceski  
Registration No. 35914  
(703) 905.2110